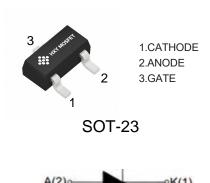


Features

- RMS on-state current to 0.8A
- General purpose switching

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MCR100-6	SOT-23	100-6	3000
MCR100-8	SOT-23	100-8	3000



Maximum Ratings (Ta=25 unless otherwise noted)

Symbol	Parameter	Part	Value	Unit
V_{DRM}	Repetitive peak off-state voltage	MCR100-6	400	V
V _{RRM}	Repetitive peak reverse voltage	MCR100-8	600	V
V _{EBO}	Emitter-Base Voltage		7	V
I _{T(RMS)}	RMS on-state current(T=60℃)		0.8	Α
I _{TSM}	Non repetitive surge peak on-state current(tp=10ms)		8	Α
I _{GM}	Peak gate current (tp=20µs,T _j =110℃)		0.2	Α
P _{GM}	Peak gate power (tp=20µs,T _j =110℃)		500	mW
P _{G(AV)}	Average gate power dissipation(T_j =110 $^{\circ}$ C)		100	mW
TJ	Operation Junction Temperature Range		-40~+110	$^{\circ}$ C
T _{stg}	Storage Temperature Range		-40~+150	$^{\circ}$

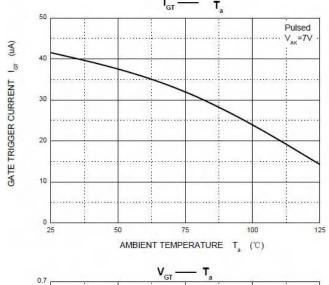
Electrical Characteristics(Ta=25 unless otherwise specified)

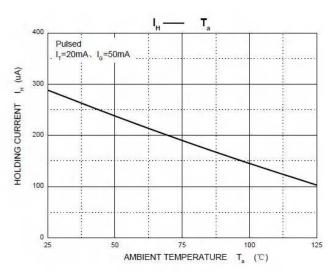
Symbol	Parameter	Test conditions	Part	Min	Тур	Max	Unit
V_{TM}	On state voltage	I _{TM} =1A ,tp=380μS				1.7	V
V _{GT}	Gate trigger voltage	V _{AK} =7V				0.8V	V
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Peak Repetitive forward and	I /I -400··A	MCR100-6	400			\/
$V_{(BR)EBO}$	Reverse blocking voltage	I _{DRM} /I _{RRM} =100μA	MCR100-8	600			V
I _{DRM}	Peak forward or reverse	\/ -\/ on\/				10	
I _{RRM}	blocking Current	V _{AK} =V _{DRM} or V _{RRM}				10	μA
I _H	Holding current	I _{HL} =20mA ,V _{AK} =7V				5	mA
I _{GT}	Gate trigger current	V _{AK} =7V		15		60	μA

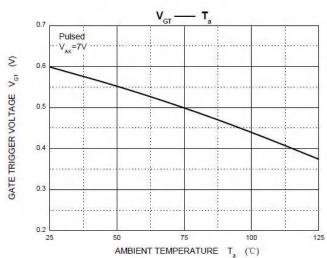
^{*} Forward current applied for 1 ms maximum duration duty cycle1%.

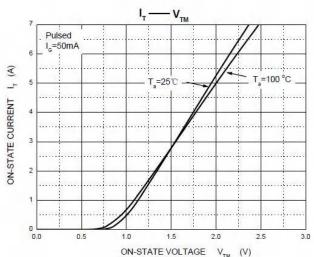


Typical Characteristics

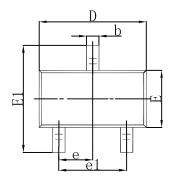


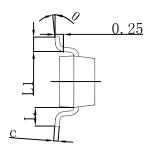


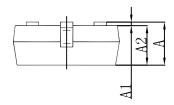




SOT-23 Package Outline Dimensions

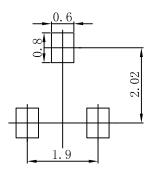






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

- 1. Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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